

STP60NF03L

N-channel 30V - 0.008Ω - 60A TO-220 STripFET™ Power MOSFET

General features

Туре	V _{DSS}	R _{DS(on)}	I _D
STP60NF03L	30V	<0.01Ω	60A

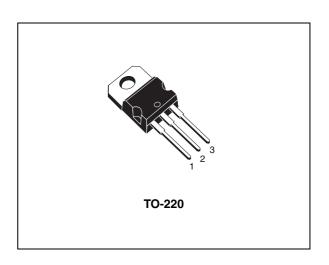
■ Low threshold drive

Description

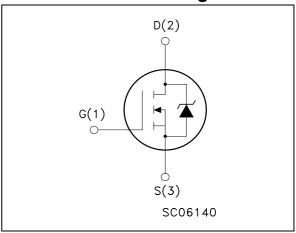
This Power MOSFET is the latest development of STMicroelectronis unique "Single Feature SizeTM" strip-based process. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging	
STP60NF03L	P60NF03L	TO-220	Tube	

Contents STP60NF03L

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STP60NF03L Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{GS}	Gate-source voltage	30	V	
V _{DGR}	Drain-gate Voltage ($R_{GS} = 20 \text{ k}\Omega$)	30	V	
V _{GS}	Gate- source Voltage	± 20	V	
I _D	Drain current (continuous) at T _C = 25°C	60	Α	
I _D	Drain current (continuous) at T _C =100°C	42	Α	
I _{DM} ⁽¹⁾	Drain current (pulsed)	240	Α	
P _{TOT}	Total dissipation at T _C = 25°C	100	W	
	Derating factor	0.67	W/°C	
E _{AS} ⁽²⁾	Single pulse avalanche energy	650	mJ	
TJ	Operating junction temperature	175	°C	
T _{stg}	Storage temperature	-65 to 175		

^{1.} Pulse width limited by safe operating area

Table 2. Thermal data

R _{thj-case}	Thermal resistance junction-case Max	1.5	°C/W
R _{thj-a}	Thermal resistance junction-ambient Max	62.5	°C/W
Rthc-sink	Thermal resistance case-sink typ	0.5	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

^{2.} Starting $T_j = 25^{\circ}C$, $I_D = 30A$, $V_{DD} = 20V$

Electrical characteristics STP60NF03L

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage $I_D = 250 \mu A, V_{GS} = 0$		30			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = Max rating, V _{DS} = Max rating @125°C			1 10	μ Α μ Α
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ±20V			± 100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.5	2.5	V
R _{DS(on)}	Static drain-source on resistance	V_{GS} = 10V, I_{D} = 30A V_{GS} = 4.5V, I_{D} = 30A		0.008 0.0095	0.010 0.015	Ω Ω

Table 4. Dynamic

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max},$ $I_D = 30A$		60		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =25V, f=1 MHz, V _{GS} =0		2550 630 215		pF pF pF
t _{d(on)}	Turn-on Delay Time Rise Time $ V_{DD} = 15 \text{V, } I_D = 30 \text{A,} \\ R_G = 4.7 \Omega, \ \ V_{GS} = 4.5 \text{V} \\ \text{(see Figure 12)} $			40 250		ns ns
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} =24V, I_D = 60A V_{GS} =5V		43 12 21	58	nC nC nC

^{1.} Pulsed: pulse duration=300µs, duty cycle 1.5%

Table 5. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				60	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				240	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} =60A, V _{GS} =0			1.5	٧
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} =60A, di/dt = 100A/ μ s, V_{DD} =15V, Tj=150°C (see Figure 14)		75 100 2.6		ns μC A

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration=300µs, duty cycle 1.5%

Electrical characteristics STP60NF03L

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

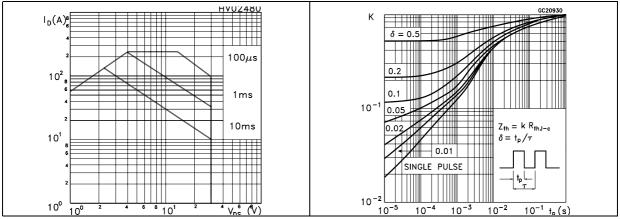


Figure 3. Output characterisics

Figure 4. Transfer characteristics

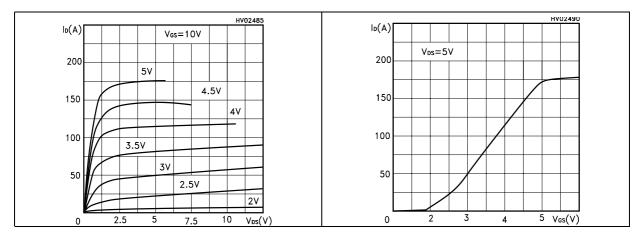
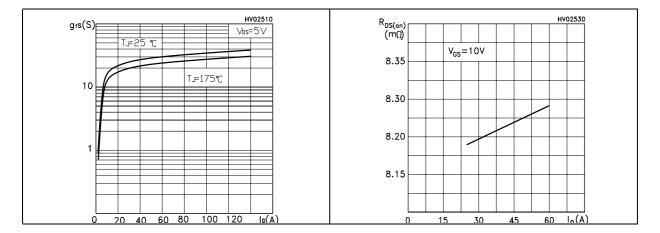


Figure 5. Transconductance

Figure 6. Static drain-source on resistance



HV02500 $V_{GS}(V)$ C(pF) f=1MHz Vgs=0V V_{DS}=24V 4000 ID=60A 3000 2000 1000 30 45 60 15 Qg(nC) 10 15 20 V_{DS}(V)

Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

Normalized gate threshold voltage Figure 9. vs temperature

Figure 10. Normalized on resistance vs temperature

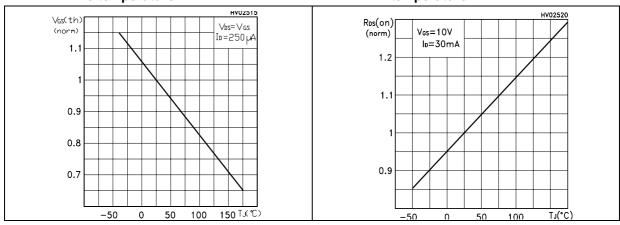
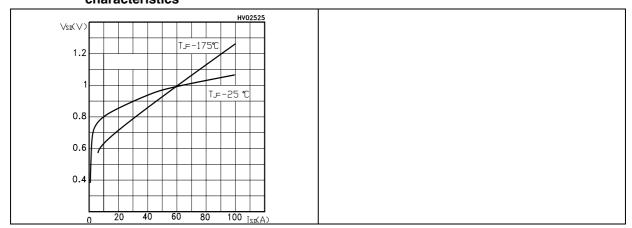


Figure 11. Source-drain diode forward characteristics



Test circuit STP60NF03L

3 Test circuit

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

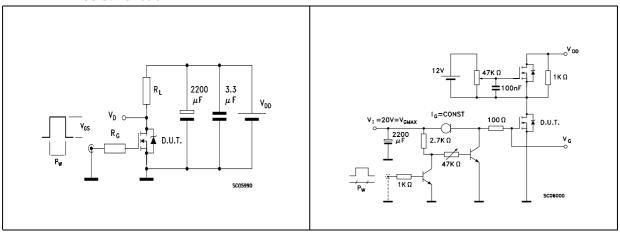


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped Inductive load test circuit

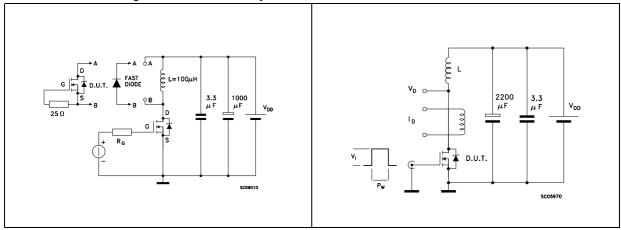
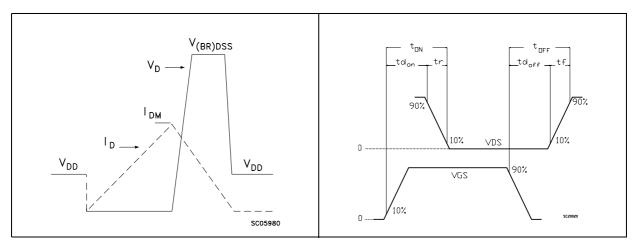


Figure 16. Unclamped inductive waveform

Figure 17. Switching time waveform

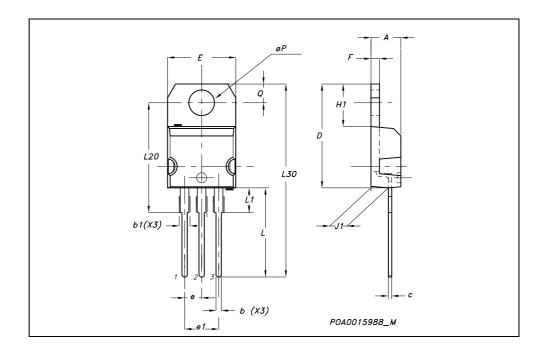


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

TO-220 MECHANICAL DATA

DIM.		mm.			inch	
DIN.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.15		1.70	0.045		0.066
С	0.49		0.70	0.019		0.027
D	15.25		15.75	0.60		0.620
E	10		10.40	0.393		0.409
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
øΡ	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



STP60NF03L Revision history

5 Revision history

Table 6. Revision history

Date	Revision	Changes
09-Sep-2004	3	Complete document
09-Aug-2006	4	New template, no content change

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